



THE DATASHEET OF
BZT585B8V2T-7

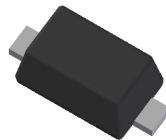


Features

- ±2.0% Tolerance on Breakdown Voltage
- Small, Low Profile Surface Mount Package
- Flat Lead Package Design for Low Profile and High Power Dissipation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208 ⑥③
- Weight: 0.001 grams (approximate)



Top View

Ordering Information (Note 4)

| Part Number (Type Number)-7* (Note 4) | Case SOD523 | Packaging 3000/Tape & Reel |
|--|----------------|-------------------------------|
|--|----------------|-------------------------------|

*Add "-7" to the appropriate type number in Electrical Characteristics Table, example: 6.2V Zener = BZT585B6V2T-7.

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



xx = Product Type Marking Code
(See Electrical Characteristics Table)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

| Characteristic | Symbol | Value | Unit |
|----------------------------|----------------|--------------------------|------|
| Forward Voltage | V _F | @ I _F = 10mA | 0.9 |
| | | @ I _F = 100mA | 1.1 |
| Continuous Forward Current | I _F | 200 | mA |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 5) | P _D | 350 | mW |
| Thermal Resistance, Junction to Ambient Air (Note 5) | R _{θJA} | 357 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +150 | °C |

Note: 5. Device mounted on FR-4 PCB with minimum recommended pad layout, as shown in Diodes Incorporated's Suggested Pad Layout document, which can be found on our website at <http://www.diodes.com>.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Type Number | Marking Codes | Zener Voltage Range (Note 6) | | | | Maximum Zener Impedance (Note 7) | | | Temperature Coefficient | Total Capacitance | Maximum Reverse Current (Note 6) | |
|-------------|---------------|----------------------------------|---------|---------|-----------------|-----------------------------------|-----------------------------------|-----------------|-------------------------|--|----------------------------------|------------------|
| | | V _Z @ I _{ZT} | | | I _{ZT} | Z _{ZT} @ I _{ZT} | Z _{ZK} @ I _{ZK} | I _{ZK} | TC @ I _{ZT} | C _T @ f = 1MHz, V _R = 0V | I _R | @ V _R |
| | | Nom (V) | Min (V) | Max (V) | mA | Ω | | mA | Typical (mV/°C) | Max (pF) | μA | V |
| BZT585B2V4T | 3C | 2.4 | 2.35 | 2.45 | 5 | 100 | 400 | 1 | -1.3 | 450 | 50 | 1 |
| BZT585B2V7T | 3E | 2.7 | 2.65 | 2.75 | 5 | 100 | 450 | 1 | -1.4 | 440 | 20 | 1 |
| BZT585B3V3T | 3H | 3.3 | 3.23 | 3.37 | 5 | 95 | 500 | 1 | -1.8 | 410 | 5 | 1 |
| BZT585B3V6T | 3J | 3.6 | 3.53 | 3.67 | 5 | 90 | 500 | 1 | -1.9 | 390 | 5 | 1 |
| BZT585B3V9T | 3K | 3.9 | 3.82 | 3.98 | 5 | 90 | 500 | 1 | -1.9 | 370 | 3 | 1 |
| BZT585B4V3T | 3L | 4.3 | 4.21 | 4.39 | 5 | 90 | 600 | 1 | -1.7 | 350 | 3 | 1 |
| BZT585B4V7T | 3M | 4.7 | 4.61 | 4.79 | 5 | 80 | 500 | 1 | -1.2 | 325 | 3 | 2 |
| BZT585B5V1T | 3N | 5.1 | 5.00 | 5.20 | 5 | 60 | 480 | 1 | -0.5 | 300 | 2 | 2 |
| BZT585B5V6T | 3P | 5.6 | 5.49 | 5.71 | 5 | 40 | 400 | 1 | 1.0 | 275 | 1 | 2 |
| BZT585B6V2T | 3S | 6.2 | 6.08 | 6.32 | 5 | 10 | 150 | 1 | 2.2 | 250 | 3 | 4 |
| BZT585B6V8T | 3T | 6.8 | 6.66 | 6.94 | 5 | 15 | 80 | 1 | 3.0 | 215 | 2 | 4 |
| BZT585B7V5T | 3U | 7.5 | 7.35 | 7.65 | 5 | 10 | 80 | 1 | 3.8 | 170 | 1 | 5 |
| BZT585B8V2T | 3V | 8.2 | 8.04 | 8.36 | 5 | 10 | 80 | 1 | 4.7 | 150 | 0.7 | 5 |
| BZT585B9V1T | 3X | 9.1 | 8.92 | 9.28 | 5 | 10 | 100 | 1 | 5.8 | 120 | 0.5 | 6 |
| BZT585B10T | 3Y | 10 | 9.80 | 10.20 | 5 | 10 | 150 | 1 | 7.0 | 110 | 0.2 | 7 |
| BZT585B11T | 3Z | 11 | 10.78 | 11.22 | 5 | 10 | 150 | 1 | 8.2 | 110 | 0.1 | 8 |
| BZT585B12T | 4A | 12 | 11.76 | 12.24 | 5 | 10 | 150 | 1 | 9.5 | 105 | 0.1 | 8 |
| BZT585B13T | 4B | 13 | 12.74 | 13.26 | 5 | 10 | 170 | 1 | 10.7 | 105 | 0.1 | 8 |
| BZT585B15T | 4D | 15 | 14.70 | 15.30 | 5 | 15 | 200 | 1 | 13.2 | 100 | 0.05 | 10.5 |
| BZT585B16T | 4E | 16 | 15.68 | 16.32 | 5 | 40 | 200 | 1 | 14.4 | 90 | 0.05 | 11.2 |
| BZT585B18T | 4F | 18 | 17.64 | 18.36 | 5 | 45 | 225 | 1 | 16.9 | 80 | 0.05 | 12.6 |
| BZT585B20T | 4G | 20 | 19.60 | 20.40 | 5 | 55 | 225 | 1 | 19.4 | 70 | 0.05 | 14.0 |
| BZT585B22T | 4H | 22 | 21.56 | 22.44 | 5 | 55 | 250 | 1 | 21.9 | 60 | 0.05 | 15.4 |
| BZT585B24T | 4J | 24 | 23.52 | 24.48 | 5 | 70 | 250 | 1 | 24.4 | 55 | 0.05 | 16.8 |
| BZT585B27T | 4K | 27 | 26.46 | 27.54 | 2 | 80 | 300 | 0.5 | 25.4 | 50 | 0.05 | 18.9 |
| BZT585B30T | 4M | 30 | 29.40 | 30.60 | 2 | 80 | 300 | 0.5 | 31.1 | 50 | 0.05 | 21.0 |
| BZT585B33T | 4N | 33 | 32.34 | 33.66 | 2 | 80 | 325 | 0.5 | 36.7 | 45 | 0.05 | 23.1 |
| BZT585B36T | 4P | 36 | 35.28 | 36.72 | 2 | 90 | 350 | 0.5 | 42.4 | 45 | 0.05 | 25.2 |
| BZT585B39T | 4R | 39 | 38.22 | 39.78 | 2 | 130 | 350 | 0.5 | 48.1 | 45 | 0.05 | 27.3 |
| BZT585B43T | 4S | 43 | 42.14 | 43.86 | 2 | 150 | 375 | 0.5 | 55.7 | 40 | 0.05 | 30.1 |

Notes: 6. Short duration pulse test used to minimize self-heating effect.
7. f = 1kHz.

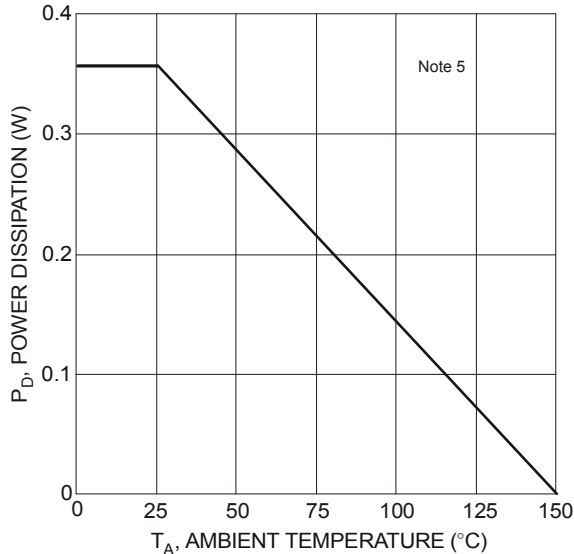


Figure 1 Power Derating Curve

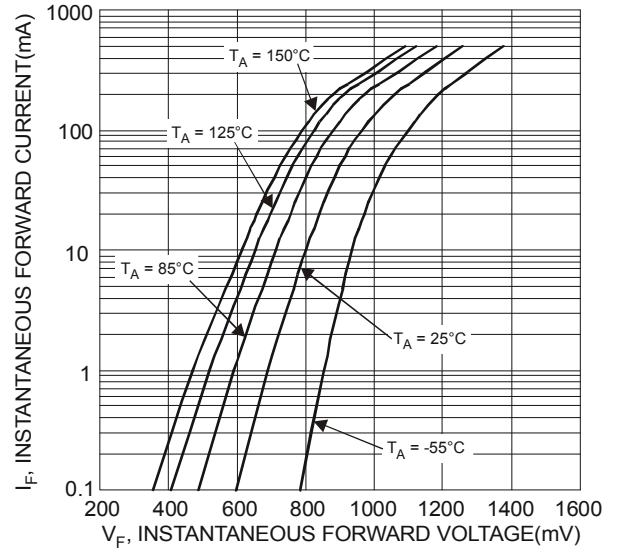


Figure 2 Typical Forward Characteristics

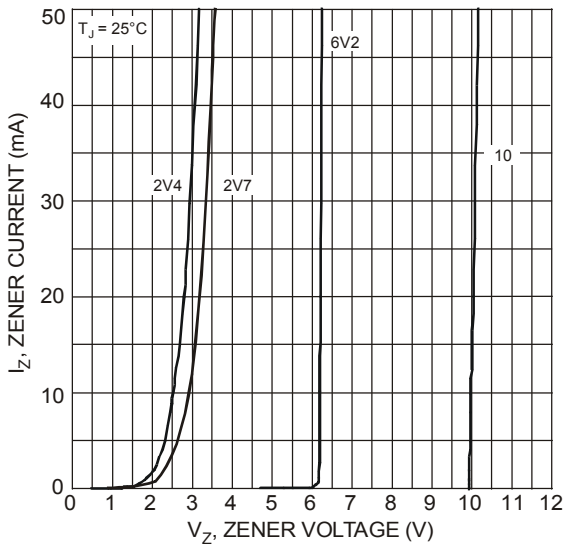


Figure 3 Typical Zener Breakdown Characteristics

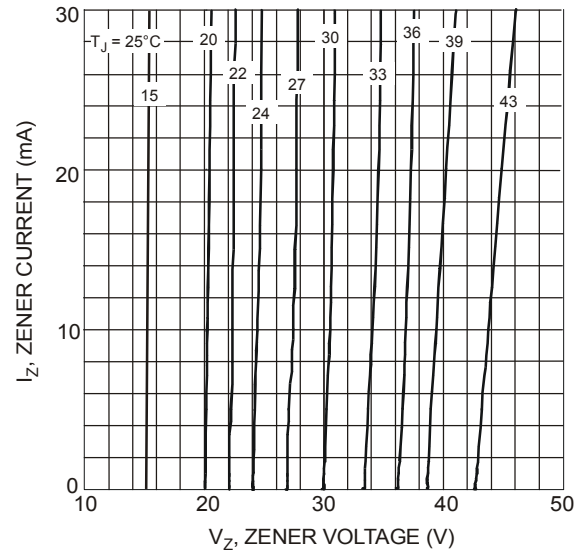


Figure 4 Typical Zener Breakdown Characteristics

Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



| SOD523 | | |
|----------------------|------|------|
| Dim | Min | Max |
| A | 0.25 | 0.35 |
| B | 0.70 | 0.90 |
| C | 1.50 | 1.70 |
| H | 1.10 | 1.30 |
| K | 0.55 | 0.65 |
| L | 0.10 | 0.30 |
| M | 0.10 | 0.12 |
| All Dimensions in mm | | |

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| G | 0.80 |
| X | 0.60 |
| X1 | 2.00 |
| Y | 0.70 |

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